Multilayer Ceramic Chip Capacitors

C2012X5R1V105K085AB





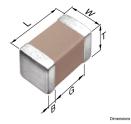


1 of 3 Creation Date : May 16, 2017 (GMT)



TDK item description C2012X5R1V105KT****

Applications	Commercial Grade Please refer to Part No. CGA4J3X5R1V105K125AB for Automotive use.	
Feature	General General (Up to 50V)	
Series	C2012 [EIA 0805]	
Status	Production (Not Recommended for New Design)	



1	Size
Length(L)	2.00mm ±0.20mm
Width(W)	1.25mm ±0.20mm
Thickness(T)	0.85mm ±0.15mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)
Recommended Land Pattern (PA)	0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)
Neconiniented Land Fattern (FD)	0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)
Neconinended Land Fattern (FC)	0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	1μF ±10%	
Rated Voltage	35VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	500ΜΩ	

Other	
Soldering Method	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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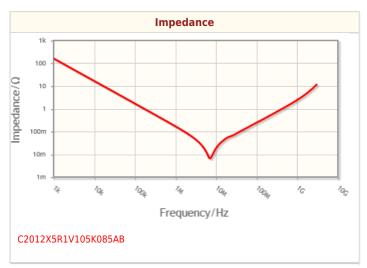


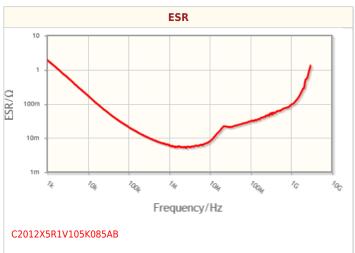


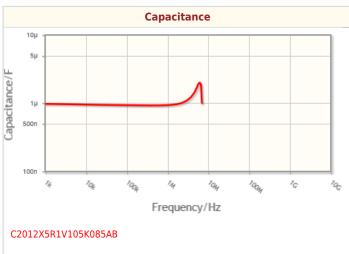


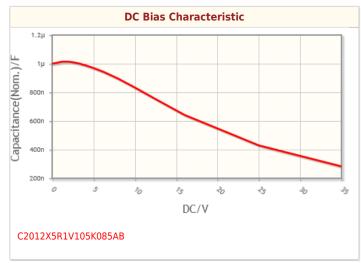


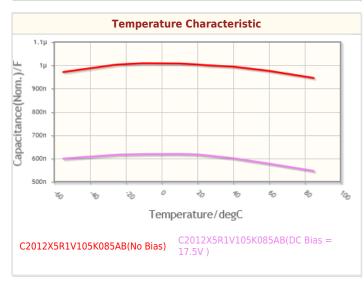
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

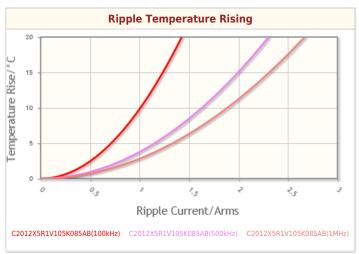












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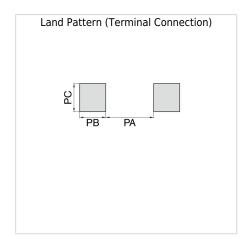








Associated Images



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